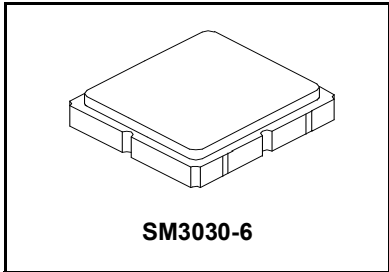


SF2134E

**897.50 MHz
SAW Filter**



- **Low-loss UHF SAW Filter**
- **Surface Mount 3.0 x 3.0 mm Package**

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	5	dBm
DC Voltage on any Non-ground Terminal	3	V
Operable Temperature Range	-45 to +105	°C
Specification Temperature Range	-20 to +75	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_c			897.5		MHz
Insertion Loss, 880 to 915 MHz	IL			2.1	3.0	dB
Amplitude Ripple, 880 to 915 MHz				1.0	2.0	dB _{P-P}
Attenuation Referenced to 0 dB						dB
DC to 860 MHz			17	19		
925 to 935 MHz			5	12.4		
935 to 960 MHz			20	24		
980 to 2000 MHz			20	22		
VSWR, 880 to 915 MHz				2:1	2.6:1	
Source Impedance	Z_s			50		Ω
Load Impedance	Z_L			50		Ω

Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint		
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	674, YWWS		
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel	
	Reel Size 13 Inch	3000 Pieces/Reel	

Electrical Connections

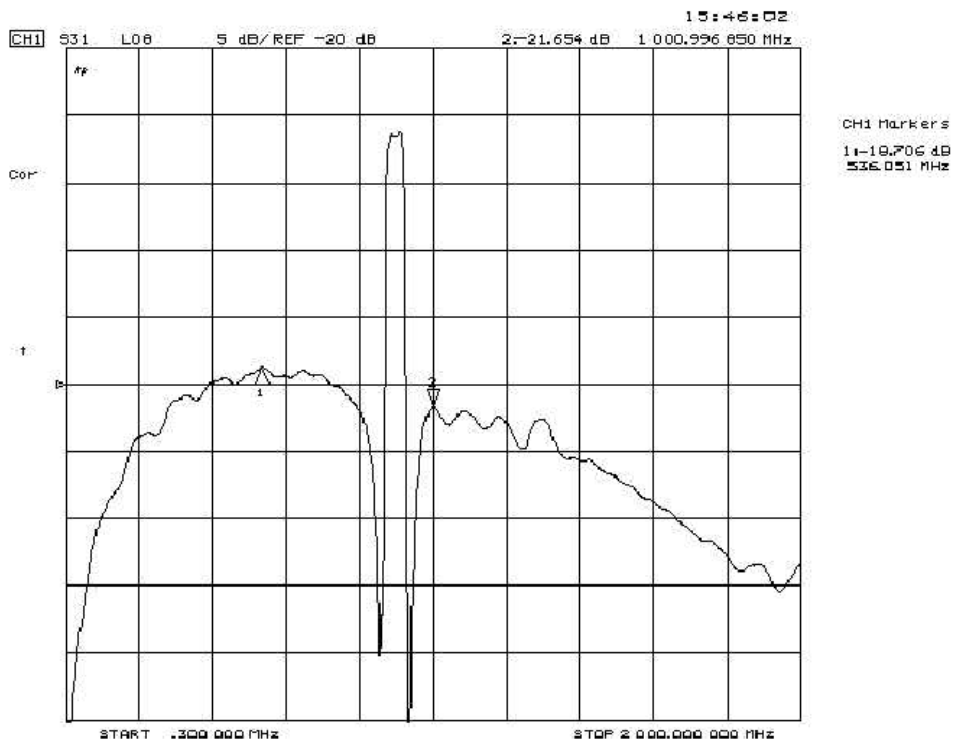
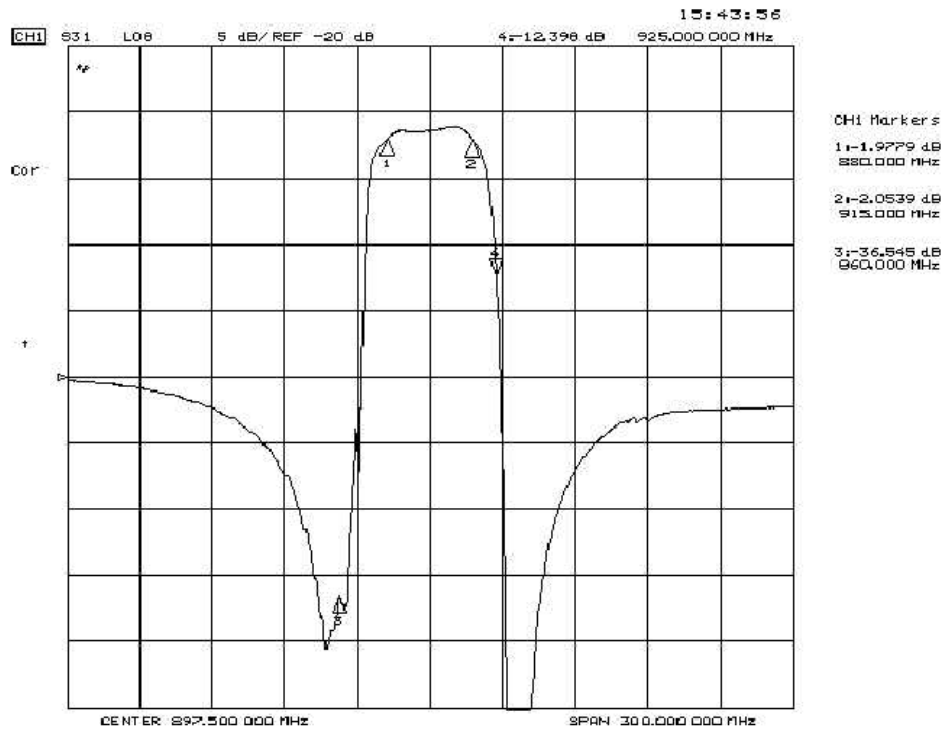
Connection	Terminals
Input	2
Output	5
Case Ground	All others

 **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

NOTES:

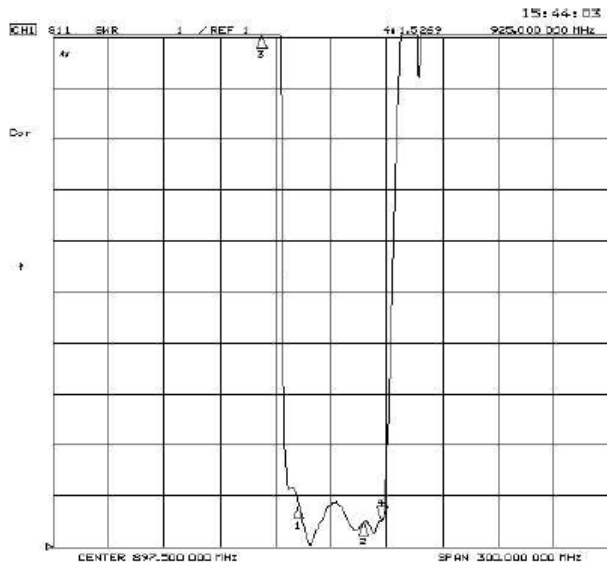
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_c .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

Filter Amplitude Response

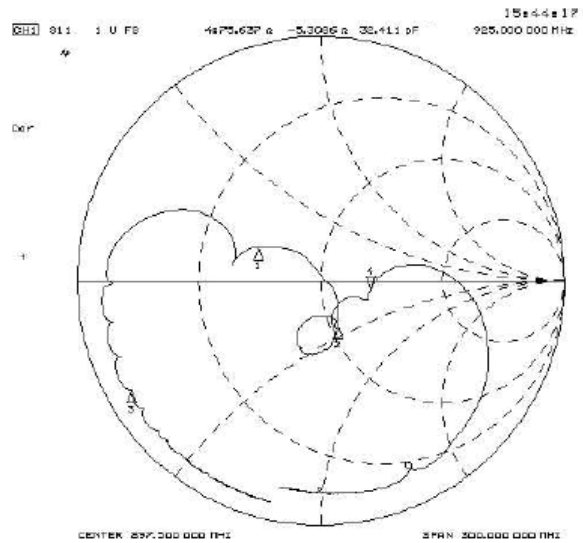


Filter Input and Output Impedance

S11

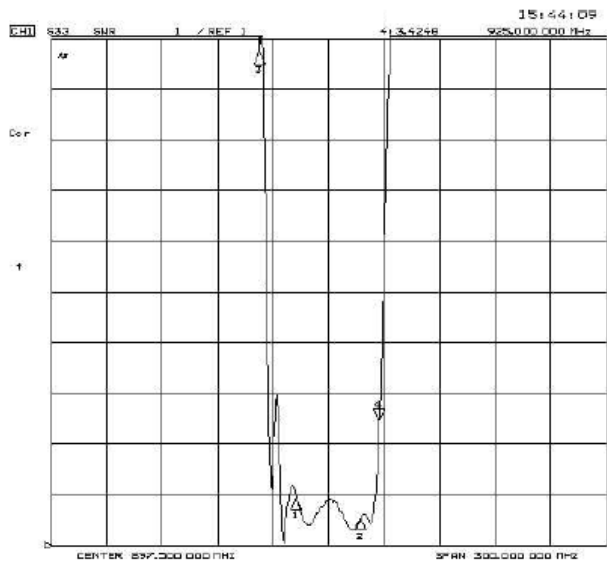


CHI Markers
 1: 1.0122
 900,000 MHz
 2: 1.0056
 915,000 MHz
 3: 18.521
 920,000 MHz

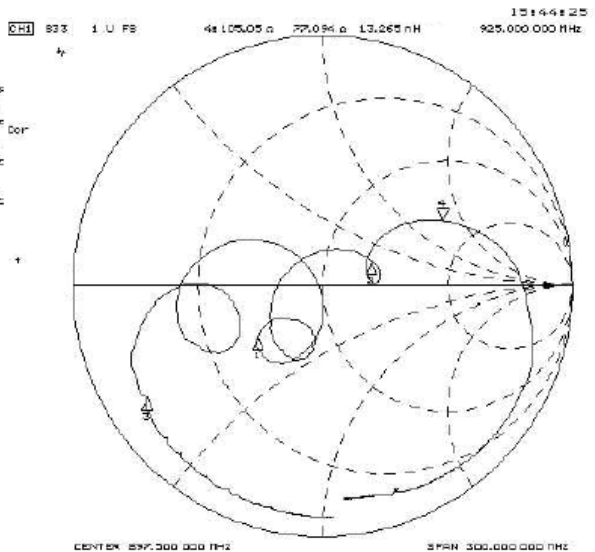


CHI Markers
 1: 29.904 a
 8.8742 a
 900,000 MHz
 2: 52.000 a
 -20.472 a
 915,000 MHz
 3: 2.0000 a
 -13.334 a
 920,000 MHz

S22



CHI Markers
 1: 1.9047
 880,000 MHz
 2: 1.5632
 915,000 MHz
 3: 10.762
 920,000 MHz

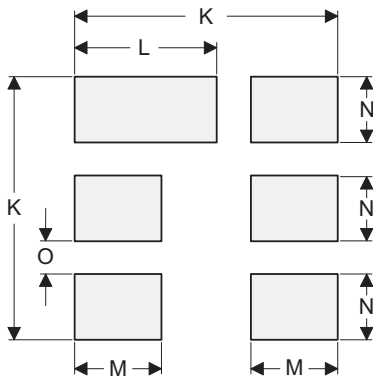
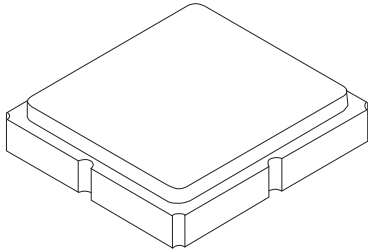


CHI Markers
 1: 27.462 a
 -12.297 a
 880,000 MHz
 2: 70.044 a
 14.714 a
 915,000 MHz
 3: 5.0000 a
 -14.316 a
 920,000 MHz

SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case

3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

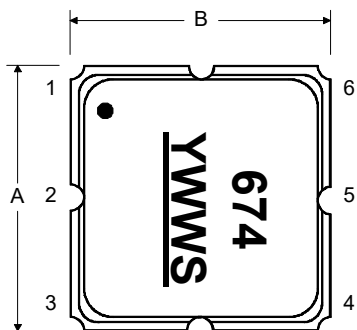
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
O		0.38			0.015	

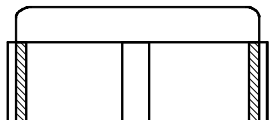
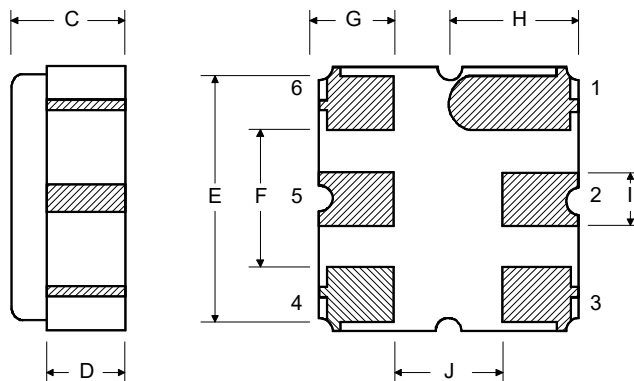
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic
Pb Free	

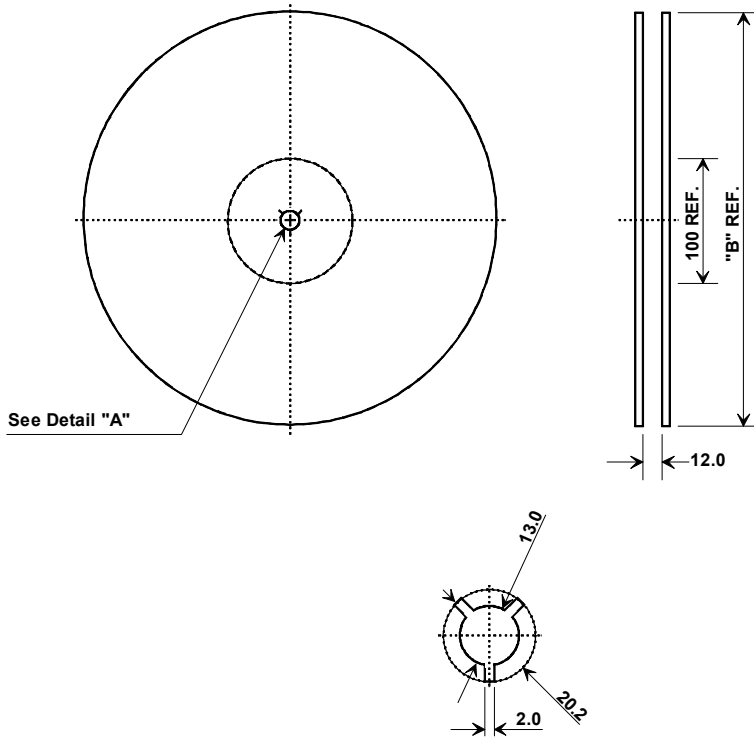
Top View



Bottom View



Tape and Reel Specifications



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm

